



Standard Test Method for Solidification Point of Bisphenol A (4,4'-Isopropylidenediphenol)¹

This standard is issued under the fixed designation D4493; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ε) indicates an editorial change since the last revision or reapproval.

1. Scope*

1.1 This test method describes the procedure for determination of the solidification point of bisphenol A (4,4'-isopropylidene diphenol).

1.2 The test method has been found applicable for determination of the solidification point between 150 and 157°C.

1.3 In determining conformance of the test results using this method to applicable specifications, results shall be rounded off in accordance with the rounding-off method of Practice E29.

1.4 The values stated in SI units are to be regarded as standard. No other units of measurement are included in this standard.

1.5 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use.* For specific hazard statements, see Section 9.

2. Referenced Documents

2.1 ASTM Standards:²

D1493 Test Method for Solidification Point of Industrial Organic Chemicals (Withdrawn 2004)³

D4297 Practice for Sampling and Handling Bisphenol A(4,4'-Isopropylidenediphenol)

D6809 Guide for Quality Control and Quality Assurance Procedures for Aromatic Hydrocarbons and Related Materials

E1 Specification for ASTM Liquid-in-Glass Thermometers

¹ This test method is under the jurisdiction of ASTM Committee D16 on Aromatic Hydrocarbons and Related Chemicals and is the direct responsibility of Subcommittee D16.02 on Oxygenated Aromatics.

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² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

³ The last approved version of this historical standard is referenced on www.astm.org.

E29 Practice for Using Significant Digits in Test Data to Determine Conformance with Specifications

E77 Test Method for Inspection and Verification of Thermometers

E691 Practice for Conducting an Interlaboratory Study to Determine the Precision of a Test Method

2.2 Other Documents:

OSHA Regulations, 29 CFR paragraphs 1910.1000 and 1910.1200⁴

3. Terminology

3.1 Definitions:

3.1.1 *solidification point, n*—the temperature at which the liquid phase of a substance is in approximate equilibrium with a relatively small amount of the same substance in its solid phase.

4. Summary of Test Method

4.1 Bisphenol A is melted, and then cooled slowly with constant agitation. When crystallization begins, and supercooling occurs, the temperature falls to a minimum, rises to a maximum, and then falls again. The maximum temperature attained after crystallization begins is the solidification point of bisphenol A.

5. Significance and Use

5.1 The solidification point of bisphenol A is a direct indication of its purity, although it gives no information as to the nature of any impurities present.

5.2 High purity bisphenol A has a solidification point of approximately 157°C.

5.3 This test method can be used for internal quality control or for setting specifications.

6. Interference

6.1 Bisphenol A that is not stored or packaged properly may absorb moisture. Absorbed moisture will lower the solidification point.

⁴ Available from U.S. Government Printing Office Superintendent of Documents, 732 N. Capitol St., NW, Mail Stop: SDE, Washington, DC 20401, <http://www.access.gpo.gov>.

*A Summary of Changes section appears at the end of this standard